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Kind regards,

Team Nexperia



# 2PC4617

# NPN general-purpose transistor

Rev. 05 — 17 November 2009

Product data sheet

# 1. Product profile

## 1.1 General description

NPN transistor in a SOT416 (SC-75) plastic package. The PNP complement is 2PA1774.

### 1.2 Features

- Low current (max. 150 mA)
- Low voltage (max. 50 V)

## 1.3 Applications

 General-purpose switching and amplification in communication, Electronic Data Processing (EDP) and consumer applications.

# 2. Pinning information

Pin Description Simplified outline Symbol

1 base
2 emitter
3 collector

# 3. Ordering information

Table 2. Ordering information

Type number	Package				
	Name	Description	Version		
2PC4617Q	SC-75	plastic surface mounted package; 3 leads	SOT416		
2PC4617R					
2PC4617S					



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# 4. Marking

Table 3. Marking codes

Type number	Marking code
2PC4617Q	ZQ
2PC4617R	ZR
2PC4617S	ZS

# 5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CBO}$	collector-base voltage	open emitter	-	60	V
$V_{CEO}$	collector-emitter voltage	open base	-	50	V
$V_{EBO}$	emitter-base voltage	open collector	-	7	V
I <sub>C</sub>	collector current (DC)		-	150	mA
I <sub>CM</sub>	peak collector current		-	200	mA
I <sub>BM</sub>	peak base current		-	200	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25  ^{\circ}C$	[1] -	150	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>j</sub>	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C

<sup>[1]</sup> Transistor mounted on an FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.

# 6. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient		<u>[1]</u> -	-	833	K/W

<sup>[1]</sup> Transistor mounted on an FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.

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# 7. Characteristics

Table 6. Characteristics

 $T_{amb}$  = 25 °C; unless otherwise specified.

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>CBO</sub>	collector-base cut-off current	$I_E = 0 A; V_{CB} = 30 V$	-	-	100	nA
		$I_E = 0 \text{ A}; V_{CB} = 30 \text{ V};$ $T_j = 150 \text{ °C}$	-	-	5	μА
I <sub>EBO</sub>	emitter-base cut-off current	$I_C = 0 A$ ; $V_{EB} = 4 V$	-	-	100	nA
h <sub>FE</sub>	DC current gain	$I_C = 1 \text{ mA}; V_{CE} = 6 \text{ V}$	[1]			
	2PC4617Q		120	-	270	
	2PC4617R		180	-	390	
	2PC4617S		270	-	560	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_C = 50 \text{ mA}; I_B = 5 \text{ mA}$	[1] -	-	200	mV
C <sub>c</sub>	collector capacitance	$I_E = i_e = 0 \text{ A};$ $V_{CB} = 12 \text{ V}; f = 1 \text{ MHz}$	-	-	1.5	pF
f <sub>T</sub>	transition frequency	$I_C = 2 \text{ mA}; V_{CE} = 12 \text{ V};$ f = 100 MHz	100	-	-	MHz

<sup>[1]</sup> Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 

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06-03-16

#### Package outline 8.

### Plastic surface-mounted package; 3 leads **SOT416** В - A Х = v M A Q С → w M B detail X 0.5 1 mm scale **DIMENSIONS (mm are the original dimensions)** UNIT D Ε $\mathsf{H}_\mathsf{E}$ Q С ٧ bp е e<sub>1</sub> $L_p$ w max 0.30 0.25 1.8 0.9 1.75 0.45 0.23 0.95 0.5 0.2 0.2 0.60 0.15 0.10 0.7 0.13 REFERENCES OUTLINE **EUROPEAN ISSUE DATE PROJECTION VERSION** IEC **JEDEC** JEITA 04-11-04 SOT416 SC-75

Package outline SOT416 (SC-75) Fig 1.

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# **Revision history**

#### Table 7. **Revision history**

**Product data sheet** 

	,			
Document ID	Release date	Data sheet status	Change notice	Supersedes
2PC4617_5	20091117	Product data sheet	-	2PC4617_4
Modifications:	including nev content.	eet was changed to reflect to be legal definitions and disclockage outline SOT416 (SC-	aimers. No changes w	
2PC4617_4	20041125	Product data sheet	<del></del>	2PC4617_3
2PC4617_3	19990521	Product specification	-	2PC4617_2
2PC4617_2	19980721	Product specification	-	2PC4617_1
2PC4617_1	19970709	Product specification	-	-

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# 10. Legal information

### 10.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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